SMB/7171/R



STRATEGIC BUSINESS PLAN (SBP)

IEC/TC or SC: Secretariat: Date:

TC 40 The Netherlands 2020-10-28

Please ensure this form is annexed to the Report to the Standardization Management Board if it has been prepared during a meeting, or sent to the Central Office promptly after its contents have been agreed by the committee.

A. STATE TITLE AND SCOPE OF TC

TC 40 "Capacitors and resistors for electronic equipment is responsible for the preparation and maintenance of international standards for:

- a. Capacitors, resistors, thermistors and varistors for use in electronic equipment.
- b. Capacitors, resistors and inductors and complete electromagnetic interference (EMI) suppression filter units for EMI suppression.
- Passive integrated circuits or networks containing resistors, capacitors, inductors or their combinations.
- d. Packaging of electronic components for automatic handling, which is an activity undertaken on behalf of all relevant component technical committees.
- e. Electric double layer capacitors for use in electric and electronic equipment.

B. MANAGEMENT STRUCTURE OF THE TC

Working Groups

WG 36: Packaging of components for automatic handling

WG 39: General items and harmonization WG 40: Capacitors, Inductors and Filters

WG 41: Resistors AG 42: TC 40 Website

WG 43: Non-Linear Resistors

C. BUSINESS ENVIRONMENT

Capacitors, resistors and inductors are so called passive components, which together with active components (semiconductors), printed wiring boards, connectors and some other components like filters, switches and fuses are basic building blocks in electronic products.

There are more than 4000 Billion discrete resistors, capacitors and inductors used annually in these products. The value of this business worldwide was more than 28 Billion Euros year 2018, and the market is fully global.

The increasing use of electronics in all fields of industry supports a continuous growth in the demand of these passive components. Today's electronic circuits have typically 6 to 25 passive components against each active component (semiconductor), and the active and passive component markets develop "hand in hand".

During the last 20 years five major technological trends have influenced the development of all components and continue to do so: miniaturization, automatic assembly of the components, electronics assembly technology (earlier surface mounting, now growingly embedding of the components), digitalization of the electronics and request for zero defects. These trends have meant a huge challenge in the development of passive components, which consequently has

resulted in a continuous need of standards for new component families and updates of existing specifications, appropriate test methods and requirements. Similar activities have influenced all styles of packaging of all various components for automatic handling, active as well as passive.

At the same time the prices of passive components have declined, in some areas dramatically. This development has forced to large consolidation in the component industry lowering the number of producing companies in the world, and moving the manufacturing industry to low cost countries, especially to China. At the same time also the electronics manufacturing, i.e. the customer industry for components, especially in consumer products, has moved from Europe, Japan and North-America largely to Asia-Pacific region. New companies have entered the component manufacturing in this region. In year 2000 still ca. 55% of capacitors were produced in Europe, Japan and North-America, when this share in 2018 was lower than 20%. Rest of the production is in Asia-Pacific region, mainly in China, but India growing as well.

D. MARKET DEMAND

The "audience" of the standards developed by TC 40 are the manufacturers of components, the users of the components [set makers = OEMs (Original Equipment Manufacturers), ODMs (Original Design Manufacturers) and EMSs (Electronics Manufacturing Services)], producers of machines for automatic handling and assembly, test houses and certifying bodies (specifically with regard to safety matters).

Although component manufacturing industry is well represented in TC 40, the OEM-, ODM-, EMS-, and machine producing industries i.e. component users are encouraged to participate more in TC 40 standardization work along with the component makers.

The growth of electronics production is fastest in the Asia-Pacific region. Active participation (P-membership) by countries from this region is developing well.

There is a continuous need for new standards in the TC 40 area and at the same time the maintenance of existing standards causes considerable amount of work. The trend to adopt IEC standards as National standards has increased also outside of Europe, and IEC standards have gained credibility over other competing standards. This puts increasing pressure to the contents and timelines of the standards in the future. There will be a growing number of requests to adopt national requirements in the IEC standards so that unified documents, accepted by everybody, can be written.

SUSTAINABILITY DEVELOPMENT GOALS INDICATE THE SUSTAINABLE DEVELOPMENT GOALS (SDGS) THAT ARE ADDRESSED BY WORK WITHIN THE TC/SC. INDICATE EACH SDG INDICATOR AFFECTED (REFERENCE SPREADSHEET AVAILABLE AT HTTPS://WWW.IEC.CH/SDG/), AND PROVIDE SPECIFIC INFORMATION ABOUT HOW THE TC/SC IS ADDRESSING THE SDG. CONSIDER BOTH DIRECT AND INDIRECT IMPACTS OF THE WORK OF THE TC/SC. GOAL 1: No Poverty **GOAL 10:** Reduced Inequality GOAL 2: Zero Hunger **GOAL 11:** Sustainable Cities and Communities \boxtimes GOAL 3: Good Health and Well-being \boxtimes **GOAL 12:** Responsible Consumption & Production **GOAL 4:** Quality Education GOAL 13: Climate Action **GOAL 5:** Gender Equality GOAL 14: Life Below Water GOAL 6: Clean Water and Sanitation GOAL 15: Life on Land \boxtimes GOAL 7: Affordable and Clean Energy **GOAL 16:** Peace & Justice Strong Institutions GOAL 8: Decent Work & Economic Growth \boxtimes GOAL 17: Partnerships to achieve the Goal GOAL 9: Industry, Innovation & Infrastructure The Sustainable Development Goals indicated above by a "X" are addressed by the work within TC 40. Although the various components for use in electronic equipment, the integrated circuits and networks as well as the packaging of electronic components, all of them being part of the TC 40 scope, have a direct or indirect involvement in (nearly) all SDG areas, a limited selection has been made of those SDG's that are influence by TC 40 the most. A distinction is made between "general SDG's" and "specific SDG's", specifically being addressed from TC 40 standing point. General SDG's SDG 10: Reduced Inequality - (Equal access to global expertise) TC 40 documents, as part of the overall IEC standards portfolio, give developing countries access to global know-how and expertise in different technology

helping to break down trade barriers and allowing innovation and competition in areas,

the market.

SDG 17: Partnerships to achieve the Goals - (Better access to technology and innovation)

> The use of TC 40 documents, as part of the overall IEC standards portfolio, facilitates participation in global trade for all countries. TC 40 develops international standards, Guidelines and Technical Reports supporting access to technology and innovation, for example on basis of knowledge transfer.

Specific SDG's

SDG 3: Good Health and Well-being – (Safe medical devices)

> TC 40 safety standards form the basis to design products, especially EMI suppression capacitors and filters for medical equipment. They are key products to guarantee the electrical and functional safety of these equipment.

SDG 7: Affordable and Clean Energy - (Energy, the golden thread)

> TC 40 documents are specifically adapted or created to meet the requirements in Solar converters, in electric vehicle power lines and in charging infrastructure. The documents make the production of safe end products possible and e.g. enable the smooth functioning of electric vehicle drives.

SDG 8: <u>Decent Work & Economic Growth</u> – (Safety of workers and economic growth)

> The passive electronic components which are standardized by TC 40 are essential components in all electronic equipment e.g. in computer hardware, television and radio. The TC 40 safety standards are the basis to protect workers from electrical

failures in equipment and to minimize the EMI disturbances.

SDG 9: Industry, Innovation & Infrastructure - (Resilient infrastructure and sustainable

industrialization)

TC 40 projects promote new technologies and methods, fostering the reduction of resource consumption, e.g. by miniaturization. In that context continuous reduction of waste and replacement of hazardous material is achieved.

SDG 12: Responsible Consumption & Production

TC 40 projects target increase of production efficiency by automation and support related knowledge and technology transfer. The documents created contain quality requirements and assessment procedures, which increase equipment reliability and provide guidance, how to prevent quality losses and creation of waste by defects caused by the wrong application of electronic components.

F. TRENDS IN TECHNOLOGY AND IN THE MARKET

The trends given in C. continue to affect the work of TC 40 also in the future. Due to large increase in hand-held and mobile electronics, and in signal frequencies, the miniaturization of components is an ongoing trend. The smallest discrete capacitors today are 0,25 mm x 0,125 mm x 0,125 mm in volume. The handling of this kind of components needs special packaging and automatic machinery. To further increase the packaging density, more and more components will be embedded in the substrates like printed wiring boards rather than assembled on their surfaces. Very thin (in the range of 150 µm) and small components used in embedding have created totally new requirements for testing and automatic handling. The function of several passive components can also be integrated together in a single passive integrated circuit component. Here the manufacturing technology can be a planar technology on silicon, ceramic or glass, or LTCC (Low Temperature Co-fired Ceramics) technology.

The TC 40 scope covers very wide area of technologies from components to complete filters and also wide range of physical sizes of components, the largest having a volume of cubic decimeters. The increasing use of delicate electronics in all areas of industry has put lot of pressure to protect the electronics of electromagnetic interferences. The need for mains voltage EMI suppression filters also in the industrial area is pushing the voltage ratings up, and creates new requirements for safety components. In general, the cost and size pressures have changed the practices in the electronics design during last years. This means that the established limitations for voltage, current, dissipation and temperature for components are increasingly challenged, and the comprehension of the physical background to these parameters has widely disappeared. This has to be taken into account in the maintenance of existing standards.

The following developments will require appropriate standardization:

- Passive integrated circuits and embedded passives
- New dielectric materials in the area of capacitors (e.g. Nb capacitors), new electrolytic materials (e.g. new conductive polymers), higher permeability of ferrites for inductors.
- New capacitor technologies, e.g. thin film capacitors
- Very thin capacitors and resistors for embedded electronics
- Increasing voltages in EMI filter area
- Very high frequency test methods for capacitors
- Electric double layer capacitors, both symmetric and asymmetric technologies, hybrid capacitors combining a capacitor and a battery, and their testing for various applications
- Packaging of thin and ultra-small components for automatic assembly
- Lower resistance values with increased precision requirements, made in affordable technologies
- Combination of different resistors on single substrates.

There is an increasing emphasis on environmental issues and restriction on materials used. Maintenance Teams should take this into account during their deliberations. The severe pressure to remove from using known, well performing flame retardant materials may influence the ability of safety capacitors to meet self-extinguishing classification tests, and new rules may be needed. The ban of lead has required major changes in the components assembly, partly threatening the

applicability of certain components for larger application areas, an issue which will continue to impose changes in the industries.

Market continues to be very volatile. After a good year 2008 the global recession meant clear drop in business for year 2009. 2010 was a year of fast recovery leading to shortage of capacitors and resistors and to increasing prices and better profitability of component producing companies. During the second half of 2011 the market again dropped considerably and this soft market situation has continued through the year 2012. From 2014 onwards the quantities of passive components showed a significant growth again, but the average selling price continues to decrease causing the total market value to grow slower or drop in some areas. The new area of Electric Double Layer Capacitors (EDLCs), so called Super or Ultra capacitors, has started to find mass market applications, and growth here is expected to be fast (double digit average annual growth rate, reaching 2 Billion Euros by 2018). New technologies have entered this area causing some confusion among customers in component selection.

The electronics industry is continuing to grow on long term, and there are no known reasons, why the use of passive components would not continue growing, also. The companies will continue moving production to low cost areas, but this development will slow down. The fast development in the area of electric and hybrid vehicles and renewable energy production (e.g. wind and solar power) will create new applications, requirements and market also for passive components, and this development should be followed carefully. The overlapping scopes between TC 40 and TC 33: Capacitors for power electronics will be challenged because of this new development, and discussions between the committees are needed.

The move of the production of electronic equipment from the OEMs to subcontracting (EMS) continues, as well as geographical relocation especially to China. This means a great challenge to find and reach new "audience" for standards, and participants to standardization work.

TC 40's main focus is on standards for components as end products, not on manufacturing technologies and materials used. In standards for packaging of components for automatic handling, attention will be paid to minimize the use of packaging materials as well as to adopting recyclable materials. New energy saving equipment / solutions may generate needs for new types of capacitors or filters and their standards.

The trend to ban hazardous substances has had, and may have indirect influence to component standards (e.g. changes in solder materials have forced to change the soldering standards), an issue to be dealt with in the regular maintenance cycles.

G. SYSTEMS APPROACH ASPECTS (SEE DIRECTIVES PART 1 ANNEX SP)

TC 40 will actively continue to promote the establishment of liaisons to other committees. Internal IEC liaisons have been established with the following TCs / SCs:

TC 9: Electrical equipment and systems for railways SC 37B: Components for low-voltage surge protection

SC 34D: Luminaires

SC 47A: Integrated circuits

SC 47D: Semiconductor devices packaging

TC 69: Electric road vehicles and electric industrial trucks

TC 91: Electronics assembly technology

TC 101: Electrostatics

TC 104: Environmental conditions, classification, and methods of test

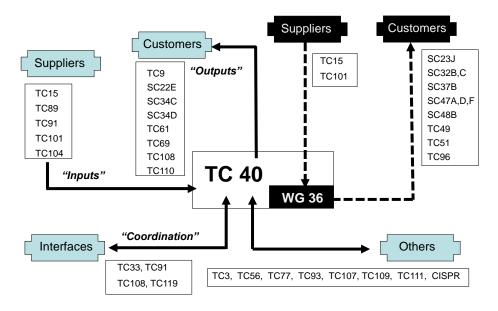
TC 108: Safety of electronic equipment within the field of audio/video, information

technology and communication technology

The System Approach of TC 40 is visualized in the overview below in which "suppliers to", "customers of", "interfaces to" and "other links to" TC 40 and its Working Group 36 are shown.

System Approach in IEC Standardization

TC 40: Capacitors and resistors for electronic equipment



Legend of TCs and SCs mentioned in the System Approach overview

- TC 3: Documentation, graphical symbols and representations of technical information
- TC 9: Electrical equipment and systems for railways
- TC 15: Solid electrical insulating materials
- TC 33: Power capacitors and their applications
- TC 49 : Piezoelectric dielectric and electrostatic devices and associated materials for frequency control, selection and detection
- TC 51: Magnetic components, ferrite and magnetic powder materials
- TC 56: Dependability
- TC 61: Safety of household and similar electrical appliances
- TC 69 : Electrical power/energy transfer systems for electrically propelled road vehicles and industrial trucks
- TC 77: Electromagnetic compatibility
- TC 89: Fire hazard testing
- TC 91: Electronics assembly technology
- TC 93 : Design automation (disbanded)
- TC 96: Transformers, reactors, power supply units and combinations thereof
- TC 101: Electrostatics
- TC 104: Environmental conditions, classification, and methods of test
- TC 107: Process management for avionics
- TC 108: Safety of electronic equipment within the field of audio/video, information technology and communication technology
- TC 109: Insulation co-ordination for low-voltage equipment
- TC 110: Electronic displays
- TC 111: Environmental standardization for electrical and electronic products and systems
- TC 119: Printed Electronics
- SC 22E: Stabilized power supplies
- SC 23J: Switches for appliances
- SC 32B: Low-voltage fuses
- SC 32C: Miniature fuses
- SC 34C: Auxiliaries for lamps
- SC 34D: Luminaires
- SC 37B: Components for low-voltage surge protection
- SC 47A: Integrated circuits
- SC 47D: Semiconductor devices packaging

SC 47F: Micro-electromechanical systems

SC 48B: Electrical connectors

H. CONFORMITY ASSESSMENT

 ${\sf TC}$ 40 prepares standards and specifications for use within the IECQ or other conformity assessment systems.

I. 3-5 YEAR PROJECTED STRATEGIC OBJECTIVES, ACTIONS, TARGET DATES

STRATEGIC OBJECTIVES 3-5 YEARS	ACTIONS TO SUPPORT THE STRATEGIC OBJECTIVES	TARGET DATE(S) TO COMPLETE THE ACTIONS
General objectives		
Establishment and utilization of TC40 Website	1. Set up AG42, decide on content and a visible place at the IEC Website	Completed.
	2. Go online with a preliminary version	Completed. TC 40 website is operational.
Focus on project management	Make available enhanced project management tools	Completed.
	Introduce quarterly reporting of performance including target setting	Completed.
To cover non-linear resistor technology	Set up of a WG	Completed.
		WG43 has formally been established.
Evolve to new assembly technologies	Embedded passive in PCB in cooperation with TC 91	-
WG 36		
Enhanced measuring methods - packaging of components for automatic handling	Measuring static electricity of packaging material / JWG13	To become Annex of IEC 60286-3, to be completed in 2021.
Packaging of very thin and small components	Develop a Technical Report	Cancelled.
Initiate a new project "Auto loading feeder".	Develop a Technical Report	2021.
Initiate a new project "Bulk blister pack".	Develop a Technical Report	Completed.
	Establish an IS	To be defined.
WG 39	ı	ı
Guidance on the structure of TC 40 component standards	1. Guidance for Generic Spec.	2021-03 (REF3 document to be formalized).
	2. Guidance for Sectional Spec.	2021-06 (REF4 document to be formalized).

	3. Guidance for Blank Detail Spec.	2021-06 (REF5 document to be formalized).	
WG 40			
EDLC standardization framework (taxonomy)	Taxonomy and terminology for symmetric and asymmetric EDLC	Determination of the strategy for symmetric and asymmetric EDLC standardization is foreseen in 2022.	
Enhanced test methods for components	Corona effects in capacitors	2022. (First draft to be available in 2021).	
WG 41			
Adapt current specification to SMD technologies	Thermal management for surface mount resistors.	2022.	
Evolve to new assembly technologies	High temperature mounting and operation on Power module.	2022.	
WG 43			
Establish liaisons to other TCs/SCs	Investigate TCs/SCs that are relevant to TC 40 / WG 43.	2023.	
Note: The progress on the actions should be reported in the RSMB.			